TOSHIBA

TOSHIBA SUPER FAST RECOVERY RECTIFIER SILICON DIFFUSED TYPE

U 0 5 N U 4 4

SWITCHING TYPE POWER SUPPLY APPLICATIONS

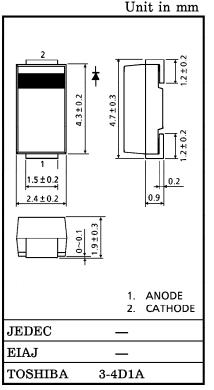
• Repetitive Peak Reverse Voltage : V_{RRM}=1000V

• Average Forward Current : I_{F (AV)}=0.5A

• Very Fast Reverse-Recovery Time : t_{rr}=100ns (Max.)

MAXIMUM RATINGS

| CHARACTERISTIC | SYMBOL | RATING | UNIT |
|--|---------------------|-----------|------|
| Repetitive Peak Reverse Voltage | v_{RRM} | 1000 | A |
| Average Forward Current | I _{F (AV)} | 0.5 | A |
| Peak One Cycle Surge Forward Current (Non-Repetitive) | $I_{	ext{FSM}}$ | 10 (50Hz) | A |
| Junction Temperature | T_{j} | -40~150 | °C |
| Storage Temperature Range | $\mathrm{T_{stg}}$ | -40~150 | °C |



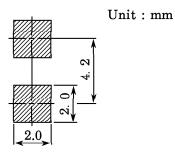
Weight: 0.06g

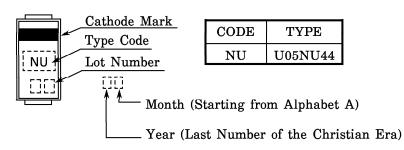
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

| CHARACTERISTIC | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|------------------------------------|-------------------|--------------------------------|------|------|------|----------------|
| Peak Forward Voltage | $V_{\mathbf{FM}}$ | $I_{\text{FM}} = 0.5 A$ | _ | _ | 3.0 | V |
| Repetitive Peak Reverse Current | I_{RRM} | $V_{RRM} = 1000V$ | | _ | 100 | μ A |
| Reverse Recovry Time | t _{rr} | $I_F=1A$, di/dt=-30A/ μ s | _ | _ | 100 | ns |
| Forward Recovry Time | tfr | $I_{\mathbf{F}} = 1.0 A$ | _ | 300 | | ns |

STANDARD SOLDERING PAD

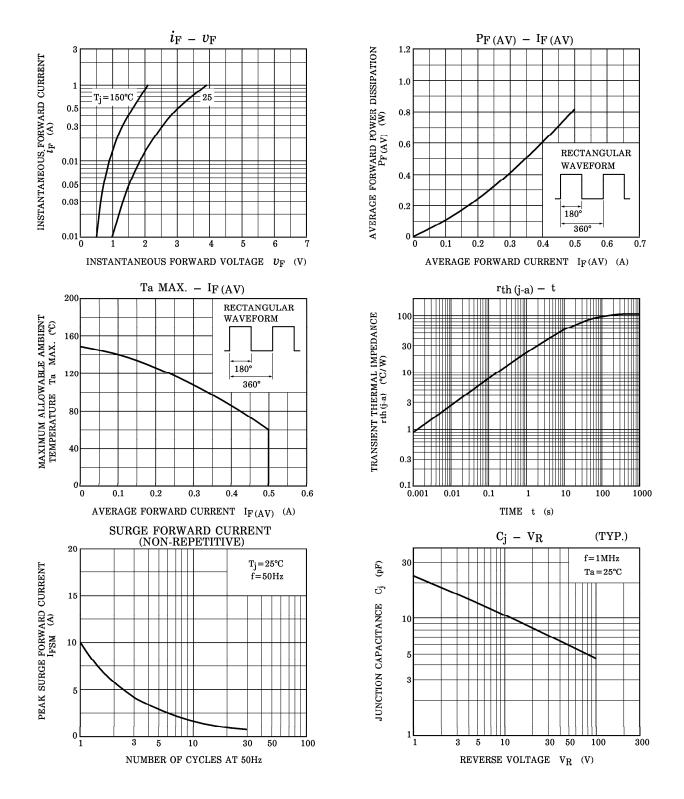
MARKING





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